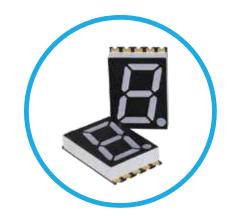


DSM7T Series Thin Surface Mount Single Digit 7-Segment LED Numeric Display



DSM7TA28105T - 0.28" (7.11mm) Digit Height Emitting Color: Pure-Green (InGaN)











Application

- People Movers
- Home Appliances
- Medical Devices

- Industrial Devices
- Automation and Controls
- Light Control

- IoT
- Transportation
- Food Service Appliances

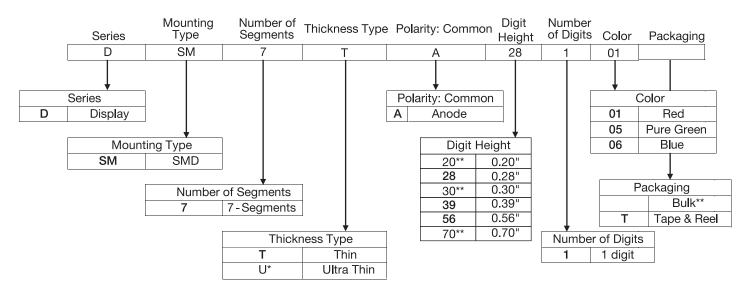
Key features

- •1-digit seven segment led numeric display
- Includes a decimal point (DP), useful when two or more seven-segment displays are connected to each other to display decimals
- White segments and grey surface
- Substrate: InGaN
- Outer dimensions: 12.0 x 7.40 x 4.00mm
- High light output
- Excellent character appearance
- Quality tested with the highest industry standard
- Side by side mounting allows space saving
- Provides the ability to reduce overall thickness of PCB, with major cost savings

- Available in 3 different digit heights and widths
- Automation-friendly tape and reel
- Technically and mechanically rugged
- Small and light, easy assembly
- Life expectancy: up to 50,000 hours
- Lower power consumption
- Allow top mount and reverse mount design
- Mechanically rugged
- Moisture Sensitive Level (MSL): 2a
- Available in blue, red and pure green
- Polarity: common anode
- Easy mounting on PC boards or sockets
- Low current operation
- Degree of protection IP50 (Dust-Protected)



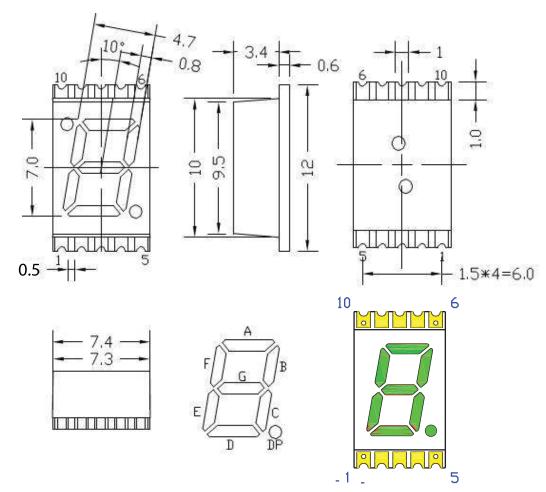
Ordering Data



*Please refer to DSM7U product datasheet for Ultra Thin Version

**Only available for DSM7U Version

Dimensions and Internal Circuit Diagram

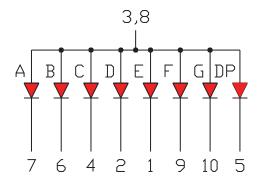


Dimensions in millimeters



Internal Circuit Diagram

Pin Connections (Common Anode)



| PIN No | Connection |
|--------|--------------|
| 1 | CATHODE E |
| 2 | CATHODE D |
| 3 | COMMON ANODE |
| 4 | CATHODE C |
| 5 | CATHODE DP |
| 6 | CATHODE B |
| 7 | CATHODE A |
| 8 | COMMON ANODE |
| 9 | CATHODE F |
| 10 | CATHODE G |

Product Specifications

Absolute Maximum Ratings while Ta=25°C

| Parameter | Minimum (m) | Maximum (M) | Unit |
|--|-------------|-------------|------|
| Forward Current I _F /Seg | | 20 | mA |
| Reverse Voltage V _R /Seg | | 5 | V |
| Operating Temperature T _{OPR} | -30 | +85 | °C |
| Storage Temperature T _{STG} | -40 | +100 | °C |
| Peak Current I _{FM} /Seg | | 60 | mA |

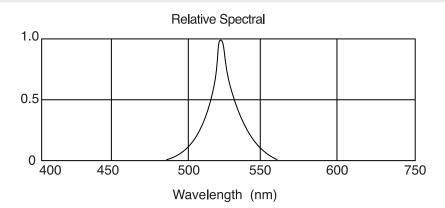
(Notice: 1/10th duty cycle, 0.1ms pulse width)

Electrical-Optical Characteristics while Ta=25°C

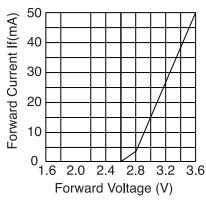
| Parameter | Condition | Unit | Minimum | Typical | Maximum |
|-------------------------------------|--------------------|------|---------|---------|---------|
| Forward Voltage V _F /Seg | IF=20mA | V | 2.6 | 3.1 | 3.6 |
| Reverse Current I _R /Seg | VR=5V | μA | | | 50 |
| Wavelength λP | IF=20mA | nm | 520 | 525 | 530 |
| Full Width at Half | IF=20mA | nm | | 17.5 | |
| Maximum Δλ | | | | | |
| Luminosity I _v /Seg | IF=20mA | mcd | 450 | 600 | 850 |
| Viewing angle | wide viewing angle | | | | |

Product Specifications

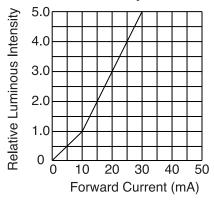
Relative Luminous Intensity @ 20mA



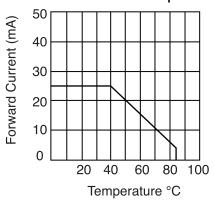
Forward Current vs. Forward Voltage



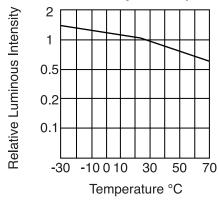
Relative Luminous Intensity vs. Forward current



Forward Current Vs. Temperature

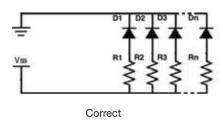


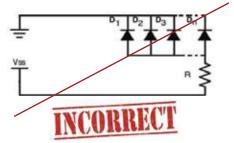
Luminous Intensity vs. Temperature



Circuit Design Notes

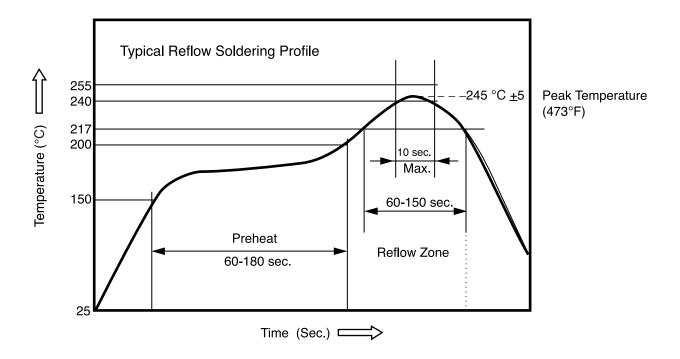
- · Always use current limit resistors when necessary
- LEDs could be electrically connected in parallel, with each current limiting resistor







Recommended Reflow Soldering Profile



| Profile Feature | Typical Parameters | | |
|-----------------------------|--------------------|--|--|
| Preheat Temperature Min | 150 °C (302°F) | | |
| Preheat Temperature Max | 200 °C (392°F) | | |
| Preheat Time | 60 -180 sec. | | |
| Reflow Starting Temperature | 217 °C (423°F) | | |
| Time Spent During Reflow | 60 -150 sec. | | |
| Reflow Peak Temperature | 245 °C (473°F) | | |

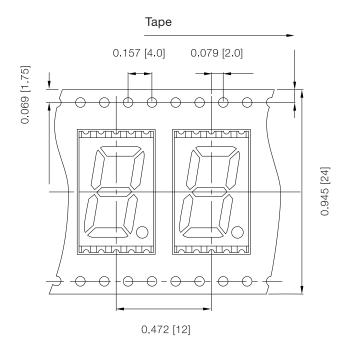
- · Manual soldering is suggested
 - Use soldering irons of which power is less than 30 Watt.
 - Keep the temperature of soldering irons below 360 °C
 - Only one soldering is allowed on each bonding pad.
 - The maximum time from when a soldering iron comes into contact with the parts that are to be connected until the joint is finished should not exceed three seconds.
 - Perform other procedures after the soldered pad cools down.
- Suggested storage conditions: 25°C +/-10°C (77°F +/-50°F), relative humidity 65% RH +/- 20% RH.

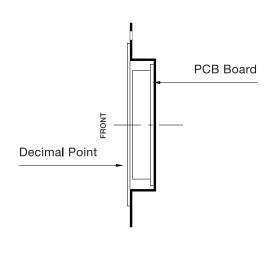


Tape and Reel Dimensions

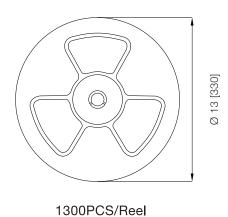
Carrier band

Electrostatic Discharge (ESD) Package Anti Static Bags Aluminium Moisture Barrier Bag.

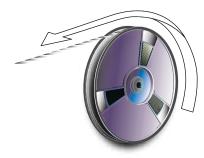




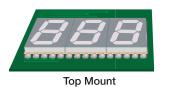
Reel Dimensions



Direction of the feed



Allow top mount or reverse mount design





Dimensions in inches [millimeters]

Compliances and Approvals







